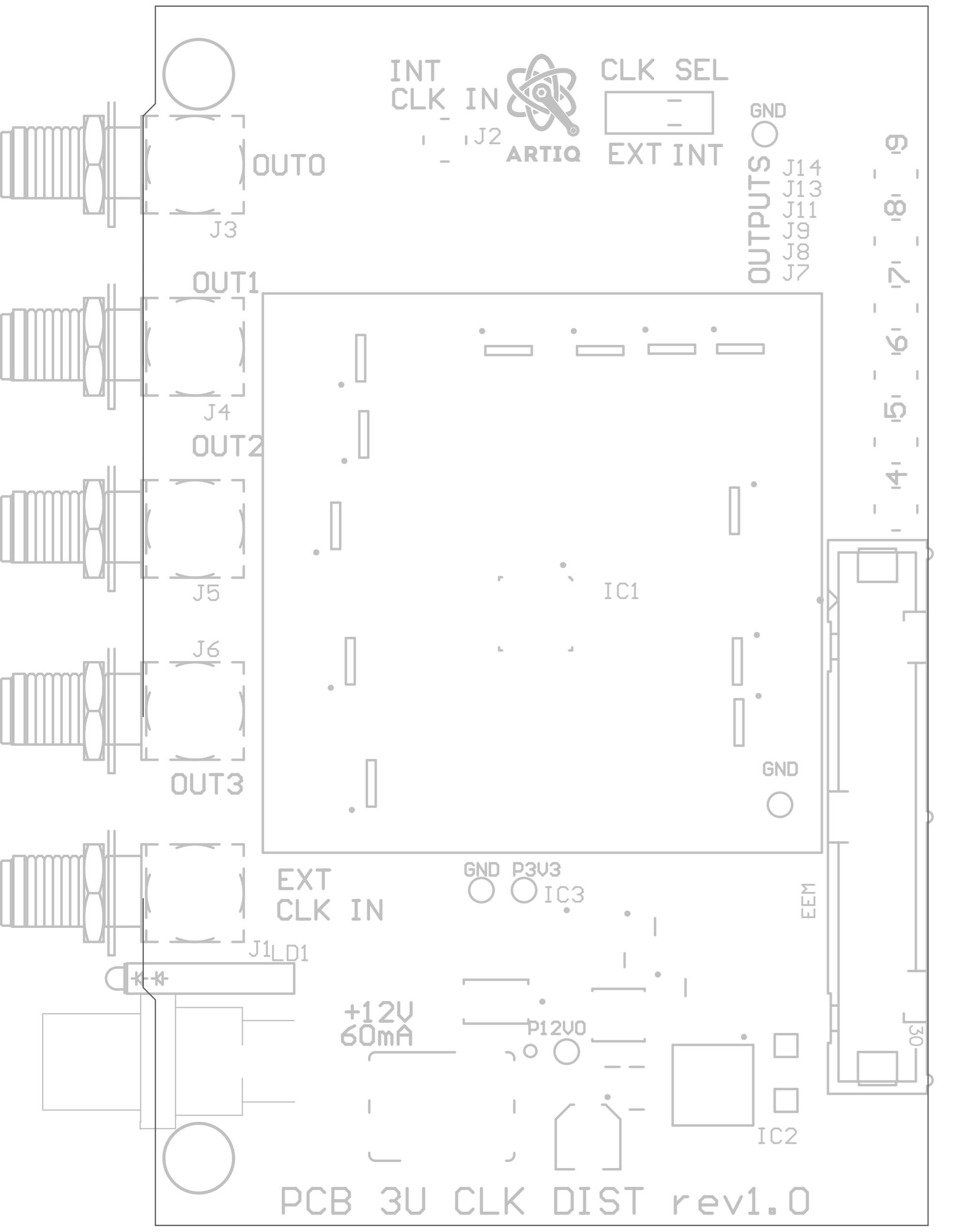
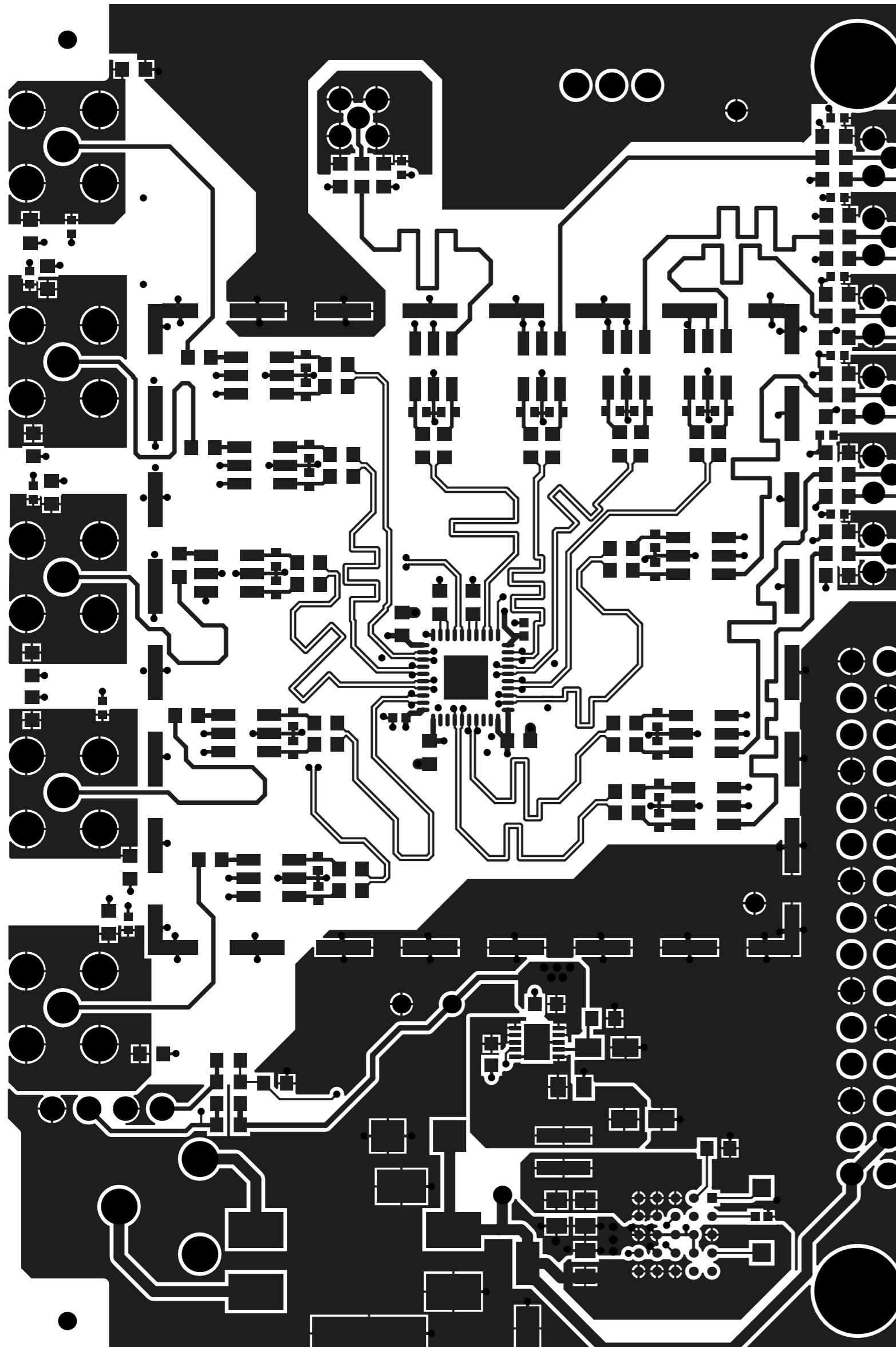
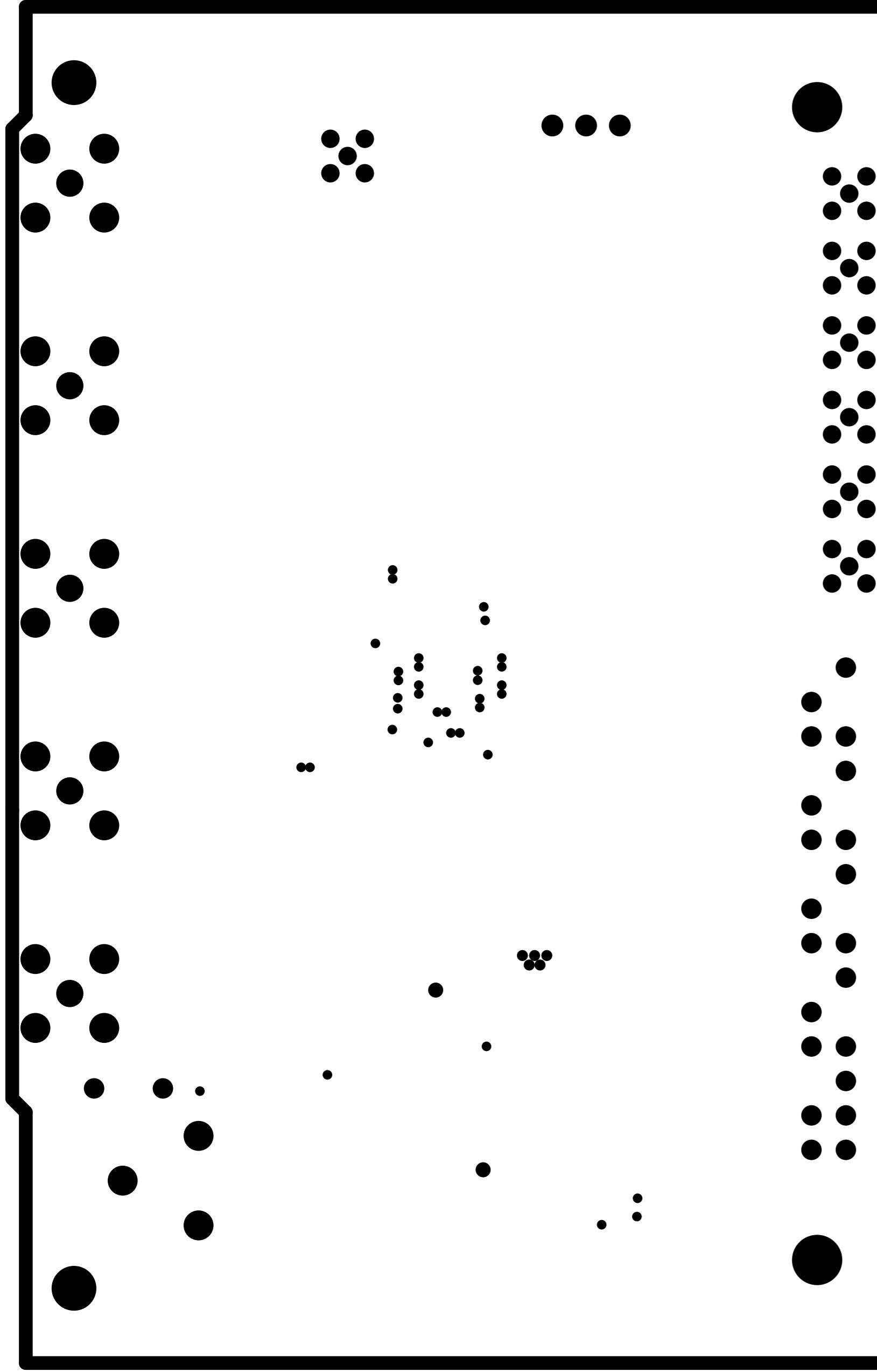


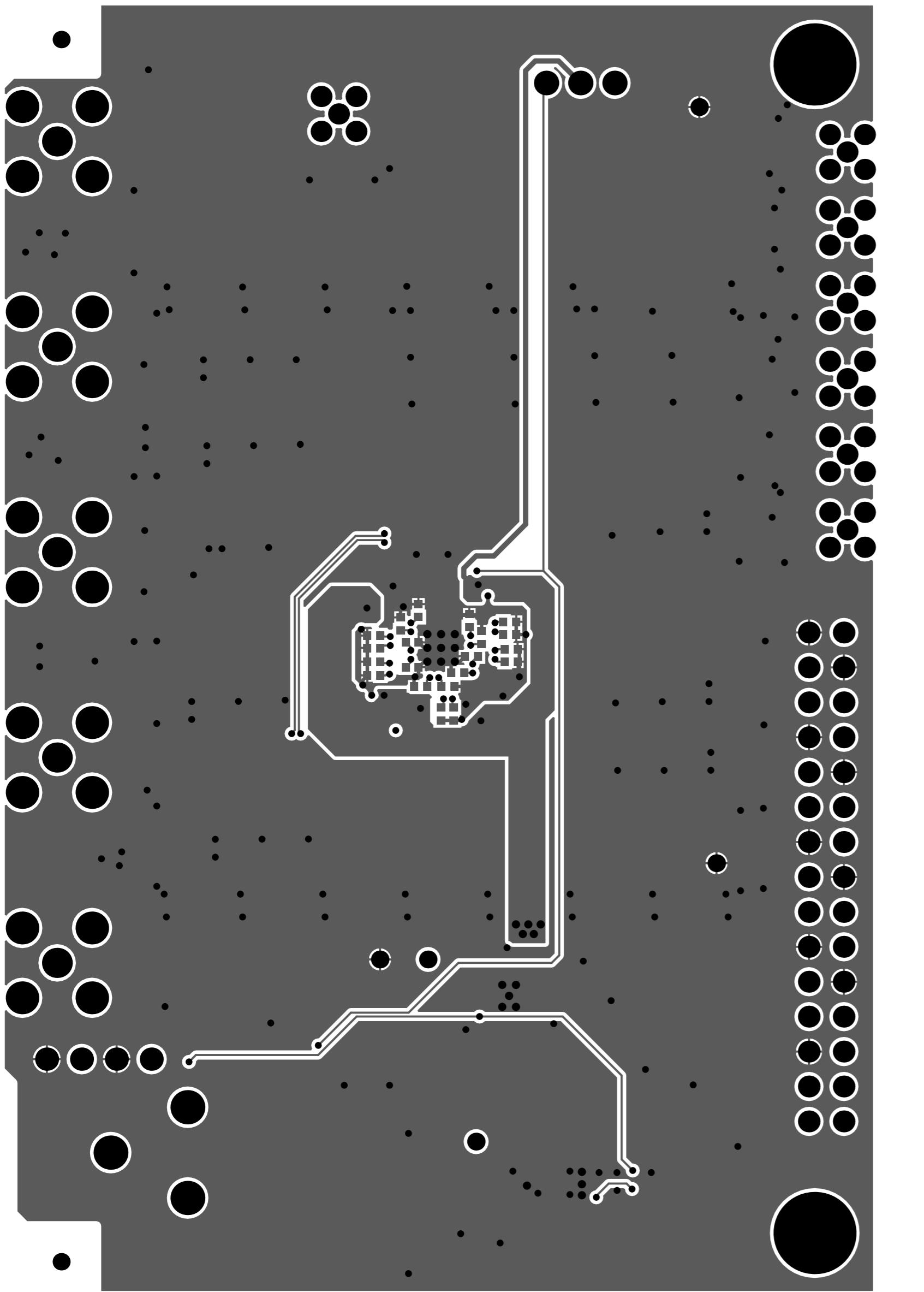
PCB 3U CLK DIST rev1.0





Layer	Name	Material	Thickness	Constant	Board Layer Stack
1	TopOverlay				
2	TopSolder	Solder Resist	0.010mm	3.5	
3	Top	Copper	0.056mm		
4	Dielectric1	FR-4	0.180mm	4.8	
5	MP(G)	Copper	0.036mm		
6	Dielectric 3		1.080mm	4.2	
7	L3	Copper	0.036mm		
8	Dielectric 4		0.180mm	4.2	
9	Bot	Copper	0.056mm		
10	BottomSolder	Solder Resist	0.010mm	3.5	
11	BottomOverlay				





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